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November 2013

FQD10N20L

N-Channel QFET® MOSFET

200 V, 7.6 A, 360 mΩ

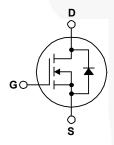
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power • 100% Avalanche Tested factor correction (PFC), and electronic lamp ballasts.

Features

- 7.6 A, 200 V, $R_{DS(on)}$ = 360 m Ω (Max.) @ V_{GS} = 10 V, $I_D = 3.8 A$
- Low Gate Charge (Typ. 13 nC)
- Low Crss (Typ. 14 pF)
- · Low Level Gate Drive Requirements Allowing **Direct Operation Form Logic Drivers**





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

| Symbol | Parameter | | FQD10N20LTM | Unit |
|-----------------------------------|--|----------|-------------|------|
| V _{DSS} | Drain-Source Voltage | | 200 | V |
| I _D | Drain Current - Continuous (T _C = 25°C) | | 7.6 | Α |
| | - Continuous (T _C = 100°C) | | 4.8 | Α |
| I _{DM} | Drain Current - Pulsed | (Note 1) | 30.4 | Α |
| V _{GSS} | Gate-Source Voltage | | ± 20 | V |
| E _{AS} | Single Pulsed Avalanche Energy | (Note 2) | 180 | mJ |
| I _{AR} | Avalanche Current | (Note 1) | 7.6 | A |
| E _{AR} | Repetitive Avalanche Energy | (Note 1) | 5.1 | mJ |
| dv/dt | Peak Diode Recovery dv/dt (Note 3) | | 5.5 | V/ns |
| P _D | Power Dissipation (T _A = 25°C) * | | 2.5 | W |
| | Power Dissipation (T _C = 25°C) | | 51 | W |
| | - Derate above 25°C | | 0.4 | W/°C |
| T _J , T _{STG} | Operating and Storage Temperature Range | | -55 to +150 | °C |
| T _L | Maximum lead temperature for soldering, 1/8" from case for 5 seconds | | 300 | °C |

Thermal Characteristics

| Symbol | Parameter | FQD10N20LTM | Unit |
|-----------------|---|-------------|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. 2.48 | | |
| В | Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max. | 110 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max. | 50 | |

Package Marking and Ordering Information

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|-----------|---------|----------------|-----------|------------|------------|
| FQD10N20LTM | FQD10N20L | DPAK | Tape and Reel | 330 mm | 16 mm | 2500 units |

Electrical Characteristics

 $T_C = 25$ °C unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|---|--|---|------|------|------|------|
| Off Cha | aracteristics | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 200 | | | V |
| ΔBV _{DSS} / ΔT _J | Breakdown Voltage Temperature Coefficient | I _D = 250 μA, Referenced to 25°C | | 0.18 | | V/°C |
| I _{DSS} | Zone Onto Valle on Burin Ormani | V _{DS} = 200 V, V _{GS} = 0 V | | | 1 | μΑ |
| | Zero Gate Voltage Drain Current | V _{DS} = 160 V, T _C = 125°C | | | 10 | μΑ |
| I _{GSSF} | Gate-Body Leakage Current, Forward | V _{GS} = 20 V, V _{DS} = 0 V | | | 100 | nA |
| I _{GSSR} | Gate-Body Leakage Current, Reverse | V _{GS} = -20 V, V _{DS} = 0 V | | | -100 | nA |
| On Cha | racteristics | | | | | |
| | | | | | | |

| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$ | 1.0 | | 2.0 | V |
|---------------------|--------------------------|--|-----|------|------|----|
| R _{DS(on)} | Static Drain-Source | $V_{GS} = 10 \text{ V}, I_D = 3.8 \text{ A}$ | | 0.29 | 0.36 | Ω |
| | On-Resistance | $V_{GS} = 5 \text{ V}, I_D = 3.8 \text{ A}$ | | 0.3 | 0.38 | 32 |
| 9 _{FS} | Forward Transconductance | $V_{DS} = 30 \text{ V}, I_{D} = 3.8 \text{ A}$ | | 9.6 | | S |

Dynamic Characteristics

| C _{iss} | Input Capacitance | $V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ | 640 | 830 | pF |
|------------------|------------------------------|--|---------|-----|----|
| C _{oss} | Output Capacitance | f = 1.0 MHz | 95 | 125 | pF |
| C _{rss} | Reverse Transfer Capacitance | | 14 | 18 | pF |

Switching Characteristics

| t _{d(on)} | Turn-On Delay Time | $V_{DD} = 100 \text{ V}, I_D = 10 \text{ A},$ | | 13 | 35 | ns |
|---------------------|---------------------|---|--|-----|-----|----|
| t _r | Turn-On Rise Time | $R_G = 25 \Omega$ | | 150 | 310 | ns |
| t _{d(off)} | Turn-Off Delay Time | (Note 4) | | 50 | 110 | ns |
| t _f | Turn-Off Fall Time | | | 95 | 200 | ns |
| Qg | Total Gate Charge | $V_{DS} = 160 \text{ V}, I_{D} = 10 \text{ A},$ | | 13 | 17 | nC |
| Q _{gs} | Gate-Source Charge | V _{GS} = 5 V (Note 4) | | 2.4 | | nC |
| Q _{gd} | Gate-Drain Charge | | | 6.1 | | nC |

Drain-Source Diode Characteristics and Maximum Ratings

| I _S | Maximum Continuous Drain-Source Diode Forward Current | | | | 7.6 | Α |
|-----------------|---|---|--|------|------|----|
| I _{SM} | Maximum Pulsed Drain-Source Diode Forward Current | | | | 30.4 | Α |
| V _{SD} | Drain-Source Diode Forward Voltage | $V_{GS} = 0 \text{ V}, I_{S} = 7.6 \text{ A}$ | | | 1.5 | V |
| t _{rr} | Reverse Recovery Time | V _{GS} = 0 V, I _S = 10 A, | | 120 | / | ns |
| Q _{rr} | Reverse Recovery Charge | $dI_F / dt = 100 A/\mu s$ | | 0.57 | // | μC |

- 1. Repetitive rating : pulse-width limited by maximum junction temperature. 2. L = 4.7 mH, I_{AS} = 7.6 A, V_{DD} = 50 V, R_G = 25 Ω , starting T_J = 25°C. 3. $I_{SD} \le$ 10 A, di/dt \le 300 A/ μ s, $V_{DD} \le$ BV $_{DSS}$, starting T_J = 25°C.

- 4. Essentially independent of operating temperature.

Typical Characteristics

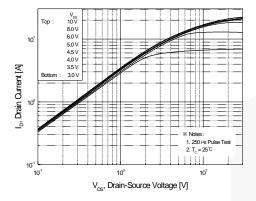


Figure 1. On-Region Characteristics

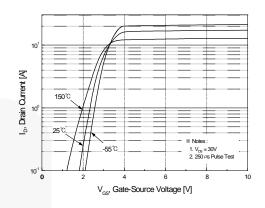


Figure 2. Transfer Characteristics

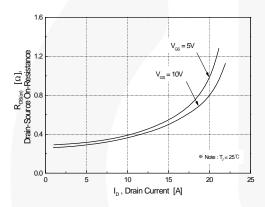


Figure 3. On-Resistance Variation vs.
Drain Current and Gate Voltage

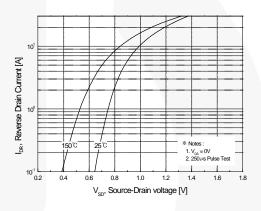


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

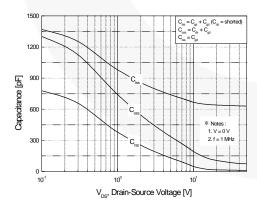


Figure 5. Capacitance Characteristics

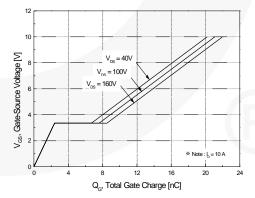


Figure 6. Gate Charge Characteristics

1.2 (Noting 1.1) 80 Year Out 1.0 (1.0) 80 Notes: 1. V_{GS} = 20 /A 2. l₂ = 250 /A T_J, Junction Temperature [°C]

Typical Characteristics (Continued)

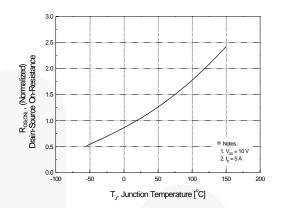
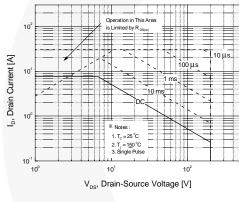


Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



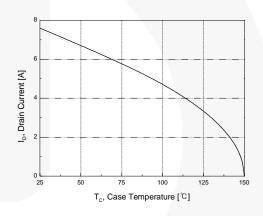


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

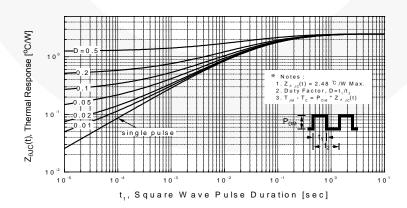


Figure 11. Transient Thermal Response Curve

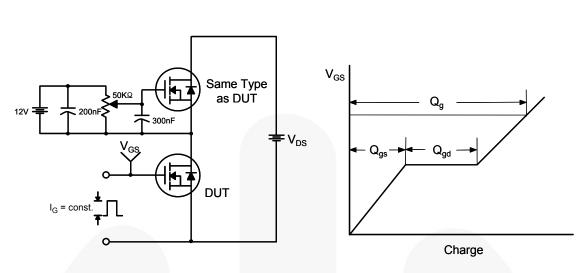


Figure 12. Gate Charge Test Circuit & Waveform

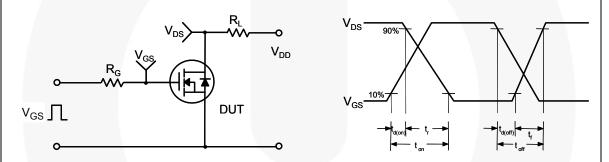


Figure 13. Resistive Switching Test Circuit & Waveforms

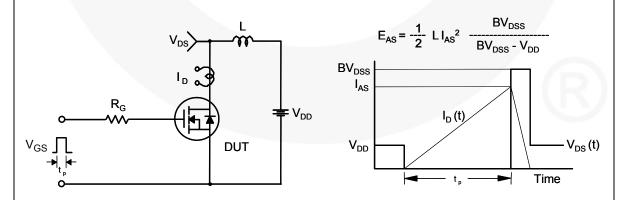
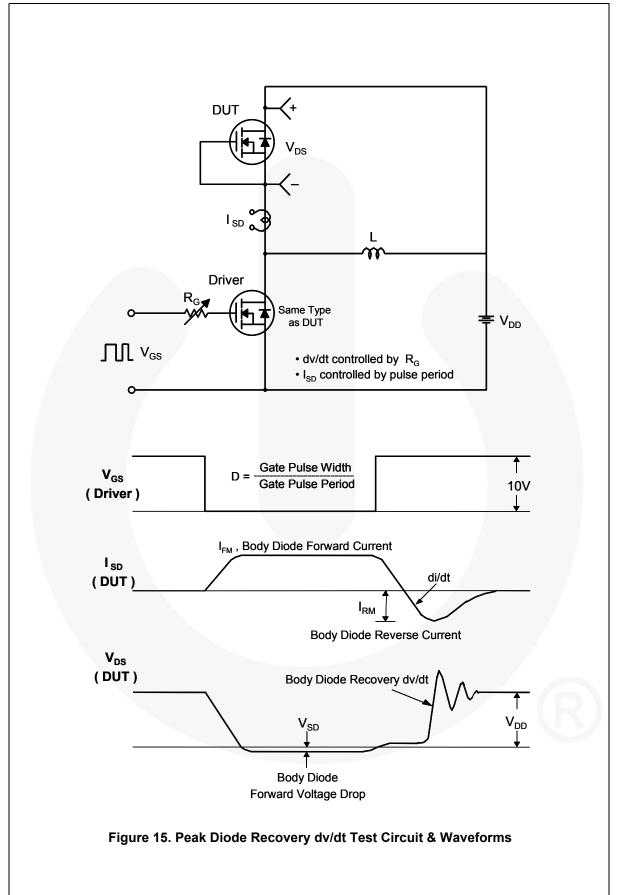
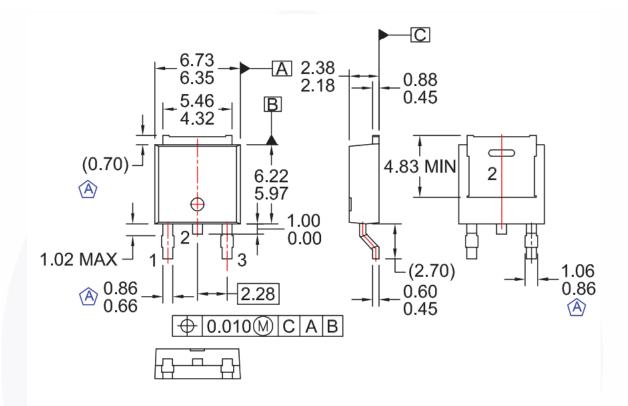


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



Mechanical Dimensions



NOTES: UNLESS OTHERWISE SPECIFIED

- (A) CONFORMS TO JEDEC TO-252 VARIATION AB EXCEPT WHERE NOTED
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DRAWING CONFORMS TO ASME Y14.5M-1994
- D) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- E) FORMERLY NAMED BD1733
- F) DRAWING FILE NAME: MKT-TO252D03REV1

Figure 16. TO-252 (D-PAK), Molded, 3-Lead, Jedec TO-252 VAR. AB, Surface Mount

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